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APPLICANTS

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\*\* CONTINUING DATA \*\*\*\*\* *NO*

\*\* FOREIGN APPLICATIONS \*\*\*\*\* *NO* *SK*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED  
 \*\* 06/01/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY SINGAPORE	SHEETS DRAWING 4	TOTAL CLAIMS 34	INDEPENDENT CLAIMS 4
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance	EXAMINER'S SIGNATURE <i>[Signature]</i>	INITIALS <i>SK</i>		

Verified and  
Acknowledged

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TITLE  
 Thermal robust semiconductor device using HfN as metal gate electrode and the manufacturing process thereof

FILING FEE  RECEIVED 1308	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue )
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